



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

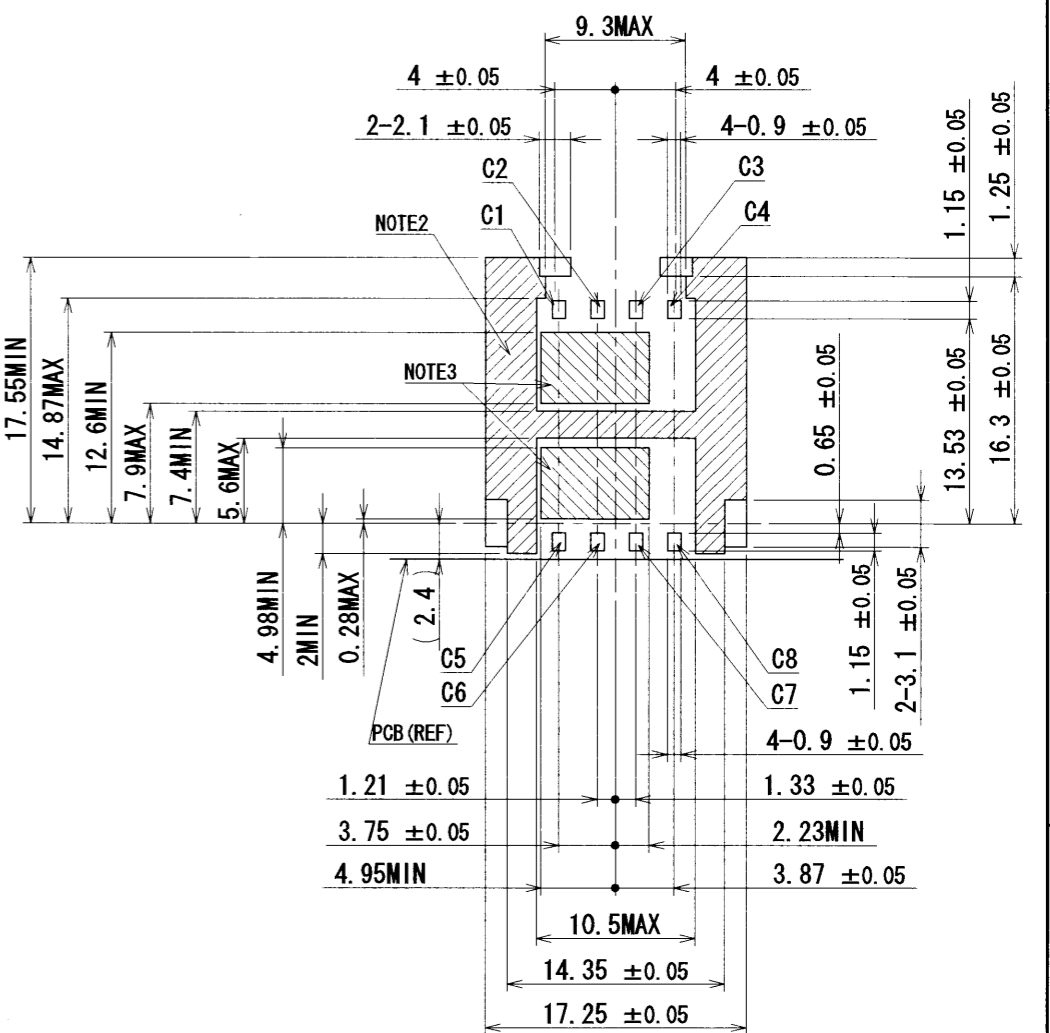
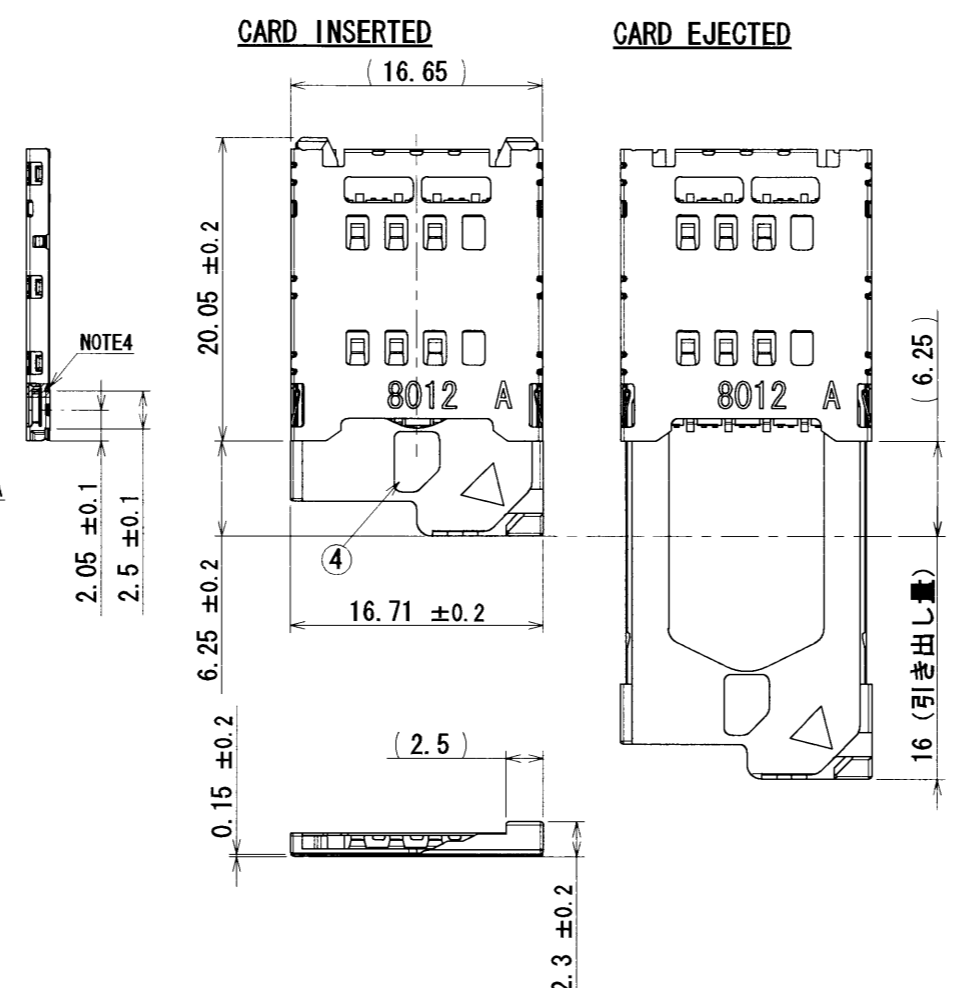
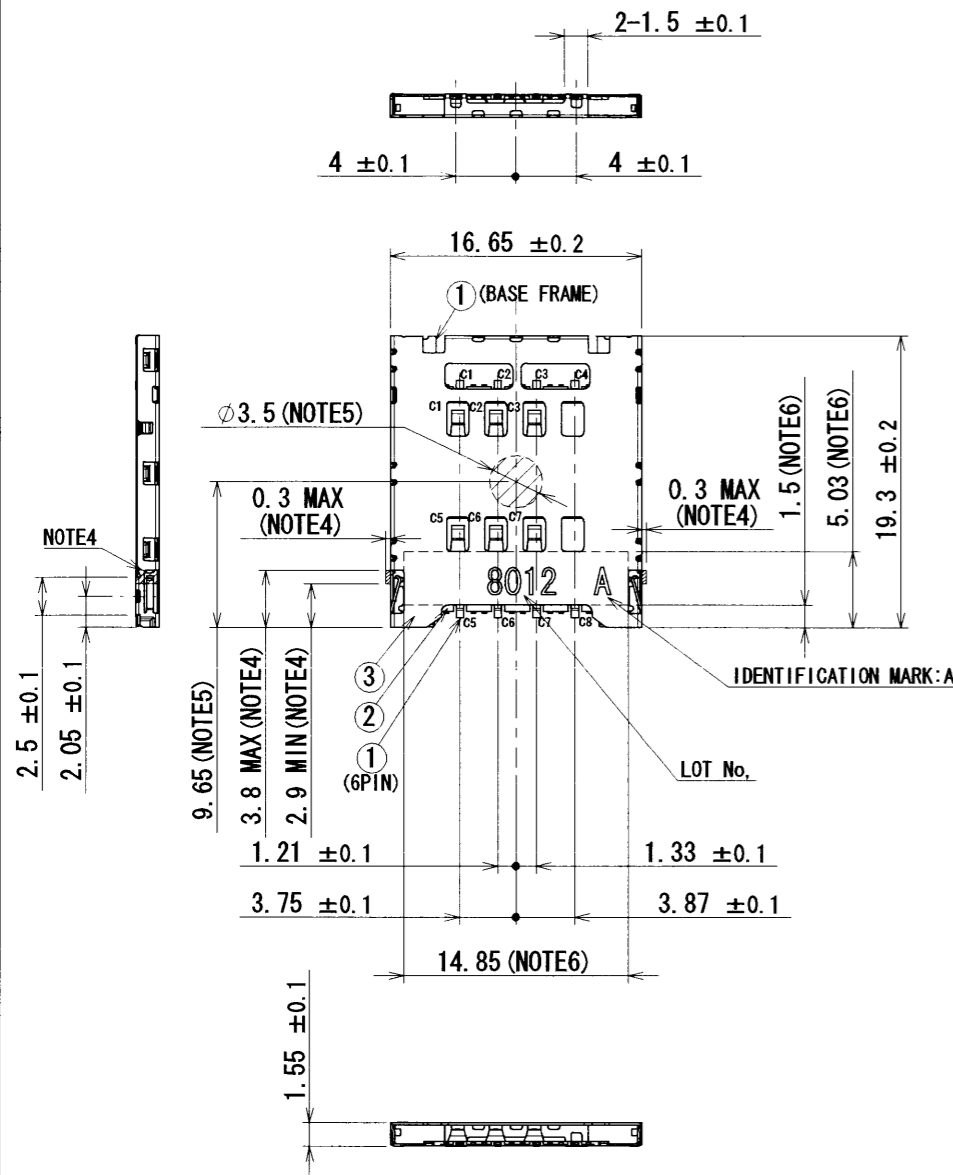
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



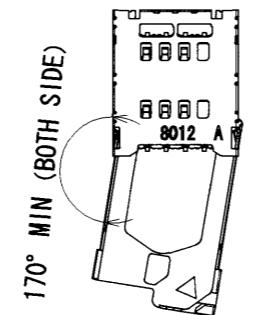
版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
2	23/MAR/2009	067607	CHANGED FORM		J. MOTOJIMA		A. Natori



APPLICABLE P. C. B. DIMENSION (REF.)
適合基板寸法 (参考)

NOTE1. COPLANARITY SHOULD BE 0.1mmMAX.
NOTE2. ONLY GND PATTERN AND GND VIA HOLE IS ALLOWED IN THIS AREA
NOTE3. NO PATTERN, VIA HOLE IN THIS AREAS.
NOTE4. NO PARTS LOCATED IN THIS AREA.
NOTE5. VACUUM AREA
NOTE6. LOT No. & IDENTIFICATION MARK AREA
NOTE7. THE THICKNESS OF REINFORCEMENT BOARD IS 0.6MIN, WHEN THE PRODUCT WILL MOUNT ON FPC.

注1. コプラナリティー0.1mm以下とする。
注2. 底面部が金属 (GND) につき、GNDパターン及びGNDビアのみ可とする。
注3. コンタクト可動部につき、パターン及びビア禁止とする。
注4. 部品搭載不可エリアを示す。
注5. 吸着エリア
注6. LOT No. 及び識別マークエリア (本品: A)
注7. FPC搭載時の補強板厚は0.6以上とする。



LOCATE THE PARTS (CASE)
170° MIN.
170° 以上になるように
筐体設定願います。

符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
4	SF8-ST51-A	1	POM (UL94 HB)	-	SJ109315
3	COVER FRAME	1	STAINLESS STEEL	GOLD OVER NICKEL	
2	HOUSING	1	GLASS FILLED LCP (UL94 V-0)	-	
1	CONTACT (WITH BASE FRAME)	6	COPPER ARROY	GOLD OVER NICKEL	

仕様書 (SPECIFICATION) SJ109313 JACS-10578* JAHL-10578*		第1版 (ORIGINAL DATE) 16/MAR/2009		尺度 (SCALE) 2:1		シリーズ (SERIES) SF8	
一般公差 (GENERAL TOLERANCE) 寸法 (DIMENSION)		製図 DR. 担当 CHK. 査閲 APPD. 承認 APPD.		名称 (TITLE) SF8V006S4A		日本航空電子工業株式会社 JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.	
角度 (ANGLES)		製図 DR. 担当 CHK. 査閲 APPD. 承認 APPD.		質量 (MASS)		図面番号 (DRAWING NO.) SJ109314	
×° ± ×°' ±		J. MOTOJIMA A. NATORI				版数 (REV.) 2	

DCF-C-212F (05.08)

